Recrystallized thin-film silicon solar cell on graphite substrate with laser single side contact and hydrogen passivation

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Abstract Laser single side contact formation (LSSC) and the hydrogen passivation process are studied and developed for crystalline silicon thin film (CSiTF) solar cells on graphite substrates. The results demonstrate that these two methods can improve cell performance by increasing the open circuit voltage and fill factor. In comparison with our previous work, we have achieved an increase of 3.4% absolute cell efficiency for a 40 μm thick 4 cm² aperture area silicon thin film solar cell on graphite substrate. Current density-voltage (J-V) measurement, quantum efficiency (QE) and light beam induced current (LBIC) are used as characterization methods.

For crystalline silicon thin film (CSiTF) solar cells on the foreign substrates, a recrystallization process plays an important role in enlarging the size of the silicon grains in order to reduce the density of the electrically active defects and increase the cell efficiencies, and hence the electron-beam recrystallization [1, 2], zone melting recrystallization (ZMR) [3, 4] and laser recrystallization [5–9] are widely developed [10–13]. Foreign substrate materials, such as ceramics [14–16] and graphite [17], are generally used for CSiTF cell fabrication with the high temperature approach. Schiller et al. [18] described a CSiTF cell concept on zircon ceramic substrates using ZMR reached 8.1% conversion efficiency. Graphite substrates can be processed at high temperature. Moreover, they are available at high purity and with thermal expansion characteristics similar to silicon. While standard graphite types will not meet the cost requirements, developments for low-cost types such as biogenic substrates are in progress [19].

In previous work, we have reported a best laboratory cell efficiency of 6.8% with the 4 cm² aperture area on the graphite substrate [20]. That cell concept is shown in Figure 1a. The laser edge isolation (LEI) technique was applied to avoid the parasitic electrical connection between the front and back contacts. This technique was proved to be a convenient and accurate method instead of the plasma etching process. By using the LEI technique, the best parallel resistance, approximately 1.7 Ω m², was achieved.

Much effort has been devoted to the metallization of CSiTF solar cells on foreign substrates. Stocks et al. [21] presented the concept of CSiTF solar cells with base front-contacts. Hebling et al. [22] realized the concept by using photolithography. Meanwhile, Lüdemann et al. [23] realized base front-contacts silicon solar cells on a SiC intermediate layer with a graphite substrate. Furthermore, Rachow et al. [24] named the concept as single side contact formation. Different microstructures of single side concepts can be formed using photolithography [21] or reactive ion etching (RIE) [25]. However, the photolithography is an expensive technology, whereas a typical RIE system consists of a vacuum chamber and a plasma generation system. Due to the development of laser techniques, laser processes are nowadays widely used in thin film solar cell fabrication. Such techniques can now be used to complete a solar cell with single side contact formation in fewer steps.

In this paper, we developed the cell concept on graphite substrates as shown in Figure 1b. The current density-voltage (J-V) curves and quantum efficiency (QE) measurements show the improvements of open circuit voltage (Voc), fill factor (FF), cell efficiency (η), and quantum efficiency due to the hydrogen bulk passivation process [26, 27] and laser single side contact (LSSC) formation.

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The combined solar cell process is carried out at a low temperature (<350 °C). The diffusion length was characterized using light beam induced current (LBIC) measurement and simulated by PC1D [28]. Here we report our 10.2% cell efficiency of a 40 μm thick and 4 cm² aperture area CSiTF solar cell on graphite substrate.

Table 1. Sample list. H⁺ denotes the hydrogen passivation process.

<table>
<thead>
<tr>
<th>Batches</th>
<th>Substrate</th>
<th>Contacts</th>
<th>H⁺</th>
<th>Duration (min)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Gra. A</td>
<td>Graphite</td>
<td>Both sides</td>
<td>No</td>
<td>–</td>
</tr>
<tr>
<td>Gra. B</td>
<td>Graphite</td>
<td>LSSC</td>
<td>No</td>
<td>–</td>
</tr>
<tr>
<td>Gra. C</td>
<td>Graphite</td>
<td>LSSC</td>
<td>Yes</td>
<td>50</td>
</tr>
<tr>
<td>Waf. A</td>
<td>p-Si wafer</td>
<td>Both sides</td>
<td>No</td>
<td>–</td>
</tr>
<tr>
<td>Waf. B</td>
<td>p-Si wafer</td>
<td>LSSC</td>
<td>No</td>
<td>–</td>
</tr>
<tr>
<td>Waf. C</td>
<td>p-Si wafer</td>
<td>LSSC</td>
<td>Yes</td>
<td>50</td>
</tr>
<tr>
<td>Waf. D</td>
<td>p-Si wafer</td>
<td>LSSC</td>
<td>Yes</td>
<td>50</td>
</tr>
<tr>
<td>Waf. E</td>
<td>p-Si wafer</td>
<td>LSSC</td>
<td>Yes</td>
<td>50</td>
</tr>
</tbody>
</table>

2 × 10^{16} \text{ cm}^{-3}. The n⁺-Si emitter was formed by spin on doping (SOD) of a phosphorous solution followed by rapid thermal processing (RTP) in a furnace [30]. The sheet resistance is in the range from 80 to 120 Ω/square. The laser edge isolation process was applied directly after the removal of the phosphorous glass [20]. The metallization of the front contacts were formed by electron beam evaporation of Ti, Pd and Ag (30 nm, 30 nm, and 5 μm thick, respectively). Finally, using plasma-enhanced chemical vapor deposition (PECVD) we deposited a silicon nitride layer with a thickness of 75 nm, which served as an antireflection coating. The total thickness of the silicon layers was about 40 μm. As shown in Figure 1d, nine cells, each with a size of 2 cm × 2 cm, have been fabricated on the 10 cm × 10 cm graphite substrate.

1.2 Sample batches

As shown in Table 1, we prepared and studied eight different batches for the comparison of LSSC formation and hydrogen passivation process. The batches based on the graphite substrates are named Gra. A, B, and C, whereas the reference batches based on the p-type Si-wafers are named Waf. A, B, C, D, and E. The batches denoted by different capital letters correspond to the different processing sequences as shown in Figures 2 and 3:

- Gra. A and Waf. A are the samples with base contacts on the back of the solar cells. They are based on the design of Figure 1a. The base contact is formed by...
Fig. 2. Processing sequence of the cells. Eight solar cell batches are prepared. Gra. denotes the cells on graphite substrate and Waf. denotes the cells on wafers as reference. Laser edge isolation (LEI), laser single side contact (LSSC) and hydrogen bulk passivation \((H^+\text{ pass})\) were applied in the cell process. Batches Gra. A–C on graphite substrates, reference batches Waf. A–C on Si wafers with the same processing after ZMR as Gra. A–C.

Fig. 3. Reference batches Waf. C–E on Si wafer with a different sequence of hydrogen passivation. (a) Processing sequence of the cells. (b) Open circuit voltage \(V_{oc}\) (top), fill factor \(FF\) (middle) and current density \(J_{sc}\) (bottom) due to the three different hydrogen passivation processes.

1.3 Laser single side contact

Based on the development of laser technology, we fabricated the base contacts on the front using a laser process, i.e. laser single side contacts instead of the Al back base contacts. Each cell from batches Gra. A and Waf. A had an aluminum base contact, which was evaporated on the back. Here we used a Nd:YVO\(_4\) laser (Rofin Power Line LP20, wavelength 1064 nm) to make approximately 30 \(\mu\)m deep trenches into the samples down to the \(p^+\)-Si layer and to obtain 3 mm wide contact stripes around the cells. After the laser trenching and LEI process, we evaporated the emitter contacts and the base contacts on the front at the same time and with the same metals Ti, Pd, and Ag.

1.4 Hydrogen passivation

The bulk recombination centers in the CSiTF solar cells can be restrained using a hydrogen passivation process, which is dependent on time and temperature. According to reference [27], the hydrogen passivation process needs less process time at high temperatures than at low temperatures. If the process temperature is 600 °C, the necessary reaction time is only about 5 min. In our case, the samples were put into the chamber at 350 °C for 50 min (microwave power: 1000 W, pressure: 0.04 mbar and hydrogen as the precursor). Experiments were carried out using a PECVD system of Roth and Rau AK1000 with microwave excitation frequency at 2.45 GHz.

The process sequence is critical for hydrogen passivation. As shown in Figure 3, in order to determine the best fabrication sequence of the hydrogen passivation, we prepared and compared three different process sequences. For this study, the reference system on wafer substrates was used in order to exclude influences from varying defect structures, as they may result from the recrystallization process. The hydrogen passivation process was included after

- the SOD diffusion processing (Waf. C);
- the laser trenching and LEI (Waf. D);
- the metallization processing (Waf. E).

1.5 Cell characterization

Internal quantum efficiency (IQE) and reflectance are measured using the pv-tools solar cell analysis system.
Table 2. Cell parameters. Open circuit parallel resistance ($R_p$), series resistance ($R_s$), voltage ($V_{oc}$), current density ($J_{sc}$), fill factor ($FF$), and efficiency ($\eta$).

<table>
<thead>
<tr>
<th>Batches</th>
<th>$R_p$ (Ω m$^2$)</th>
<th>$R_s$ (Ω cm$^2$)</th>
<th>$V_{oc}$ (mV)</th>
<th>$J_{sc}$ (mA/cm$^2$)</th>
<th>$FF$ (%)</th>
<th>$\eta$ (%)</th>
<th>$\eta$ (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Gra. A</td>
<td>1.53</td>
<td>1.52</td>
<td>426</td>
<td>21.3</td>
<td>56.7</td>
<td>5.18</td>
<td>6.79</td>
</tr>
<tr>
<td>Gra. B</td>
<td>1.97</td>
<td>1.06</td>
<td>469</td>
<td>234</td>
<td>66.5</td>
<td>7.33</td>
<td>7.81</td>
</tr>
<tr>
<td>Gra. C</td>
<td>2.47</td>
<td>1.05</td>
<td>499</td>
<td>262</td>
<td>67.7</td>
<td>8.86</td>
<td>10.2</td>
</tr>
<tr>
<td>Waf. A</td>
<td>1.08</td>
<td>2.22</td>
<td>450</td>
<td>255</td>
<td>49.0</td>
<td>5.74</td>
<td>7.68</td>
</tr>
<tr>
<td>Waf. B</td>
<td>2.51</td>
<td>2.77</td>
<td>501</td>
<td>290</td>
<td>57.0</td>
<td>7.18</td>
<td>9.19</td>
</tr>
<tr>
<td>Waf. C</td>
<td>3.18</td>
<td>2.85</td>
<td>534</td>
<td>263</td>
<td>58.7</td>
<td>8.29</td>
<td>10.1</td>
</tr>
<tr>
<td>Waf. D</td>
<td>0.33</td>
<td>3.24</td>
<td>465</td>
<td>23.9</td>
<td>49.2</td>
<td>5.52</td>
<td>7.77</td>
</tr>
<tr>
<td>Waf. E</td>
<td>0.03</td>
<td>2.21</td>
<td>467</td>
<td>26.7</td>
<td>47.7</td>
<td>5.97</td>
<td>7.14</td>
</tr>
</tbody>
</table>

LOANA at the University of Konstanz and using the Enlitech solar cell analysis system QE-R at i-MEET. Light beam induced current (LBiC) measurements were carried out by using Semilab WT2000, which has four light sources (976 nm, 951 nm, 846 nm and 662 nm). The diffusion length was calculated from the LBiC measurements at various wavelengths.

2 Results and discussion

2.1 J-V characterization

Table 2 lists the parameters obtained from the illuminated and dark J-V measurements. We arranged the $J_{sc}$, $V_{oc}$ and $FF$ data of all the samples in the form of a box chart, as shown in Figure 3b. These results were used to identify the best hydrogen passivation sequence, which is described in Section 2.1.1. Furthermore, we observed significant improvement in $V_{oc}$ and $FF$ with hydrogen bulk passivation and LSSC formation in Figure 4, which is described in Section 2.1.2.

2.1.1 Hydrogen passivation sequence on reference batches

Comparing the results of these three batches (Waf. C–E) in Figure 3b and Table 2, we found the best hydrogen passivation sequence is the hydrogen bulk passivation process of Waf. C. This batch has the highest average values of $R_p$, $V_{oc}$, and $FF$ among the three batches.

In the case of Waf. D, the hydrogen passivation was applied after the laser trenching and LEI process. This process sequence resulted in lower cell performance than Waf. C, which is most probably due to laser induced defects. Slaoui et al. [31] reported the hydrogen passivation of laser induced defects, which demonstrated that the quality of the hydrogen passivation highly depends on the temperature of the passivation process.

In the case of Waf. E, the contacts were already evaporated before the hydrogen passivation process. As shown in Table 2, this process sequence resulted in extremely lower average parallel resistance $R_p$ ($\bar{R}_p$) than Waf. C, which further resulted in a low average $FF$ ($\bar{FF}$). This was assumed due to the fact that the front contacts (Ag/Pd/Ti) penetrated through the thin emitter layer into the base layer during the passivation process at 350 °C [32].

Accordingly, the best hydrogen passivation sequence was made directly after the phosphor diffusion process, which was also applied to fabricate Gra. C.

2.1.2 Batches with hydrogen passivation and LSSC on graphite substrates

In order to confirm the improvement by LSSC formation and hydrogen passivation, we further compared the results of the graphite substrate batches (Gra. A–C) and the reference batches (Waf. A–C). There are three different formations as shown in Figure 2.

As shown in Figure 4, both the graphite-based (Gra.) and reference (Waf.) batches exhibit similar variations in
The best cell in Gra. C (cell No. 5) i.e. Gra. C-5, has 3.17 Ω m from Gra. B and C. The best performance in LSSC formation and hydrogen passivation applied have bulk recombination, and therefore the batches, with both sides contact formati on, since the collected cur- rent bypassed the intermediate layer and the graphite sub- strate. Moreover, the hydrogen passivation reduced the back surfaces of the reference cells were not passivated. Therefore, the improvement using hydrogen bulk passiva- tion cannot counteract the detrimental effect of the back surface recombination.

Those inequalities indicate that the batches with LSSC formation have better performance than the batches with both sides contact formation. The possible reason is that the LSSC formation had less recombination losses than the both-side contact formation, since the collected current bypassed the intermediate layer and the graphite substrate. Moreover, the hydrogen passivation reduced the bulk recombination, and therefore the batches, with both LSSC formation and hydrogen passivation applied have the best performance in $V_{oc}$ and $FF$. We also observed that the $J_{sc}$ of the cells based on graphite substrates had the same trend:

$$J_{sc} \text{(Gra. A)} < J_{sc} \text{(Gra. B)} < J_{sc} \text{(Gra. C).}$$

We observed that the values of $J_{sc}$ were improved using the LSSC formation by comparison $J_{sc}$ (Gra. A) and $J_{sc}$ (Gra. B). We also observed $J_{sc}$ (Gra. C) was the highest due to the applied LSSC and hydrogen bulk passivation. However, the values of $J_{sc}$ of the reference cells based on mc-Si wafers did not have the same trend. According to the process sequence, as shown in Figure 2, the reason can be that the reference cells were with neither an intermediate layer nor a ZMR process. Moreover, the back surfaces of the reference cells were not passivated. Therefore, the improvement using hydrogen bulk passivation cannot counteract the detrimental effect of the back surface recombination.

Figure 5 shows illuminated $J-V$ curves of the best cells from Gra. B and C. The best cell in Gra. C (cell No. 5) i.e. Gra. C-5, has 3.17 Ω m$^2$ parallel resistance, 502 mV $V_{oc}$ and 67.2% fill factor. In contrast, the best cell in Gra. B i.e. Gra. B-8, without the hydrogen bulk passivation has less $V_{oc}$ and $J_{sc}$ mainly due to the defects in the bulk. To date, we have achieved a cell efficiency of 10.2%, which is the highest efficiency of a 40 μm thick crystalline silicon solar cell on graphite substrate with a 4 cm$^2$ aperture area.

### 2.2 Quantum efficiency

Figure 6 shows the measured IQE of Gra. B-8 and Gra. C-5, the simulated IQE using PC1D and the reflectance of the Gra. C-5. Gra. B-8 had the shorter diffusion length and lower quantum efficiency than Gra. C-5 due to the surface and bulk recombination without the hydrogen bulk passivation. The simulation parameters are shown in Table 3. The simulation results are in very good agreement with the measured curve. The main difference is that the simulated $V_{oc}$ is about 50 mV higher than the measured one. This may be a result of spatial non-uniformities due to various crystal grains, which cannot be accounted for in 1-dimensional simulations using PC1D.

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Results</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Device area</td>
<td>4</td>
<td>cm$^2$</td>
</tr>
<tr>
<td>Base contact</td>
<td>0.7125</td>
<td>Ω</td>
</tr>
<tr>
<td>Thickness</td>
<td>40</td>
<td>μm</td>
</tr>
<tr>
<td>Input p-type background doping</td>
<td>$2 \times 10^{16}$</td>
<td>cm$^{-3}$</td>
</tr>
<tr>
<td>Sheet Resistance</td>
<td>112</td>
<td>Ω/square</td>
</tr>
<tr>
<td>1st rear diffusion</td>
<td>$4 \times 10^{18}$</td>
<td>cm$^{-3}$</td>
</tr>
<tr>
<td>Bulk recombination*</td>
<td>0.2</td>
<td>μs</td>
</tr>
<tr>
<td>Front surface recombination*</td>
<td>$8 \times 10^5$</td>
<td>cm/s</td>
</tr>
<tr>
<td>Output</td>
<td></td>
<td></td>
</tr>
<tr>
<td>$V_{oc}$</td>
<td>0.103</td>
<td>A</td>
</tr>
<tr>
<td>Efficiency</td>
<td>567.9</td>
<td>mV</td>
</tr>
<tr>
<td></td>
<td>10.15</td>
<td>%</td>
</tr>
</tbody>
</table>
The anti-reflection coating layers made up of silicon nitride 75 nm thick. The refractive index of the layer is approximately 2. Figure 6 shows that the minimum reflection of the reflectance curve is close to 600 nm, since we fabricated it close to the maximum of the number of incident photons. The SiN layers were formed at a low temperature without optimized passivation properties, which cannot reduce the surface recombination in the emitter. Therefore, as shown in the IQE curves, that was assumed to be the main reason why the cell has a spectral response below 90% in the range from 400 nm to 550 nm. In the range from 550 nm to 1000 nm, the IQE goes down gradually due to the bulk and rear recombination loss. In addition, the QE results also reveal that, there are some possibilities for improving the cell performance further, such as by lowering the surface recombination and by optimizing the bulk passivation process.

2.3 Diffusion length

The measured average diffusion length of Gra. C-5 is about 120 μm using the LBIC, however, the value is larger than the cell thickness, since these three wavelengths (976 nm, 951 nm and 846 nm) have the longer penetration lengths than the 40 μm thick active layers of the cells.

Therefore, we obtained the effective diffusion length of the CSiTF solar cell by using PC1D. The real thickness of the cell was included into the PC1D model. We used this model to fit the measured IQE. The simulated IQE characteristic curves for diffusion lengths were 15, 22, 40, and 100 μm, respectively. The effective diffusion length was varied for the fitting and is approximately 22 μm. This result again demonstrates that a surface passivation process and a higher layer quality are necessary for further increasing cell efficiency.

3 Conclusions

In this work, we have presented a new strategy to improve CSiTF solar cell on graphite substrates, using the laser single side contact formation and the hydrogen bulk passivation process at a low temperature. Both methods result in an increase of Voc and FF. The recombination losses in the bulk and the surface are the main limitations on the cell performance. We achieved 10.2% cell efficiency on an aperture area of 4 cm².

By comparing different sequences with J-V measurement, we also found the best sequence for inclusion of the hydrogen bulk passivation. This significantly improved the cell performance.

We found that one-side contact with LSSC formation is better than front and back contact formation for CSiTF solar cells on graphite substrates. Furthermore, the cell fabrication process can be simplified by making the metallization of all contacts at the same time. The successful application of the LSSC indicates a potential improvement: it is possible to obtain good cell performance at a cost-effective price, while all contacts are on the front side and the impact by substrates is reduced using the LSSC formation. Not only for the CSiTF solar cells on graphite substrates, but we also expect that the LSSC strategy and the best hydrogen bulk passivation process sequence can be applied for the cells based on other high temperature foreign substrates.

So far, a SiOx intermediate layer is supposed to provide a better quality of surface passivation than a SiC layer [33]. In addition, the batches have not included optimum design of metal grids, light trapping, surface passivation or local diffusion. Thus, the results of both LBIC and QE show possibilities for further improvement.

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